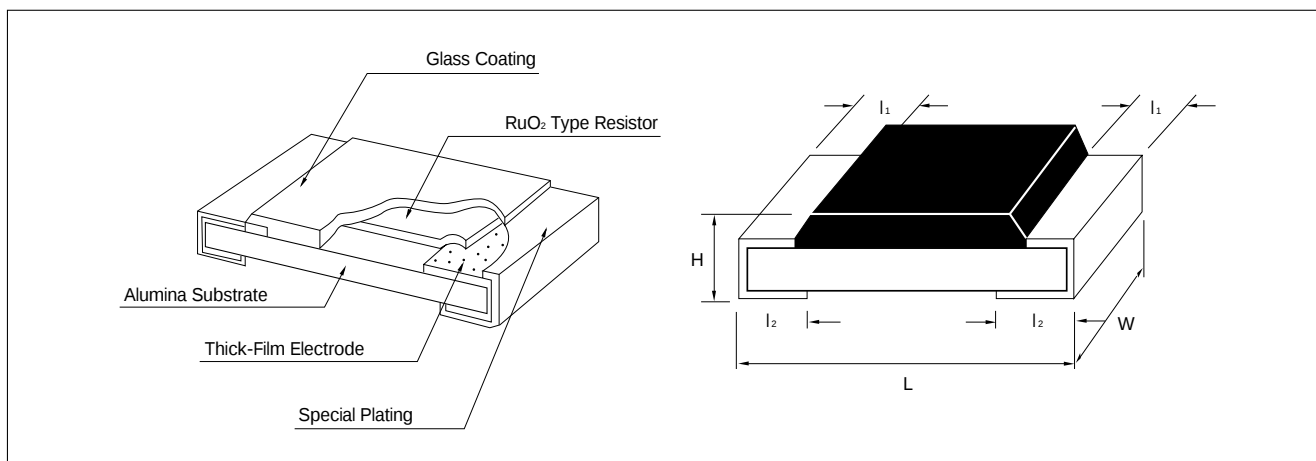


THICK FILM CHIP RESISTORS

STRUTURE AND DIMENSIONS



(UNIT : mm)

Type	L	W	H	l ₁	l ₂
RC1005(1/16W)	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.25 ± 0.10
RC1608(1/10W)	1.60 ± 0.10	0.80 ± 0.15	0.45 ± 0.10	0.30 ± 0.20	0.35 ± 0.10
RC2012(1/8W)	2.00 ± 0.20	1.25 ± 0.15	0.50 ± 0.10	0.40 ± 0.20	0.35 ± 0.20
RC3216(1/4W)	3.20 ± 0.20	1.60 ± 0.15	0.55 ± 0.10	0.45 ± 0.20	0.40 ± 0.20
RC3225(1/4W)	3.20 ± 0.20	2.55 ± 0.20	0.55 ± 0.10	0.45 ± 0.20	0.40 ± 0.20
RC5025(1/2W)	5.00 ± 0.15	2.50 ± 0.15	0.55 ± 0.15	0.60 ± 0.20	0.60 ± 0.20
RC6432(1W)	6.30 ± 0.15	3.20 ± 0.15	0.55 ± 0.15	0.60 ± 0.20	0.60 ± 0.20

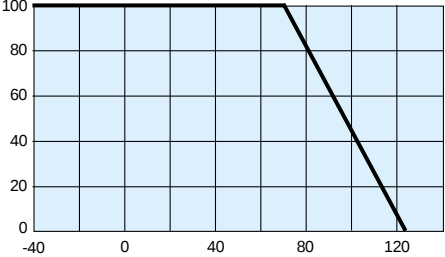
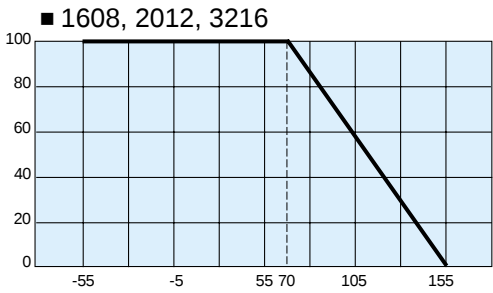
PARTS NUMBERING SYSTEM

www.DataSheet4U.com

1	2	3	4	5
RC	2012	J	100	CS
Code Designation	Dimension (mm)	Resistance Tolerance	Resistance Value	Packaging Code
Chip Resistor -RC :Glass Coating -RH :Polymer Epoxy Coating	1005 : 1.0×0.5 1608 : 1.6×0.8 2012 : 2.0×1.25 3216 : 3.2×1.6 3225 : 3.2×2.55 5025 : 5.0×2.5 6432 : 6.4×3.2	D : $\pm 0.5\%$ F : $\pm 1\%$ G : $\pm 2\%$ J : $\pm 5\%$ K : $\pm 10\%$	1st two digits represents Significant figures. The last digit represents the number of zeros. Jumper chip is represented as 000	AS : Tape Packaging. 13" CS : Tape Packaging. 7" ES : Tape Packaging. 10" BS : Bulk Packaging.
Resistance Value Marking				
3 or 4 digit coding system. (IEC Coding System)				

THICK FILM CHIP RESISTORS

GENERAL SPECIFICATION

Description	RC1005	RC1608	RC2012	RC3216	RC3225	RC5025	RC6432
Power Rating (W) at 70℃	0.063W	0.10W	0.125W	0.25W	0.25W	0.5W	1W
Power Derating Curve	  ■ 1608, 2012, 3216 The rated power is the maximum continuous loading power at 70℃ ambient temperature. For ambient temperature's above 70℃ the loading power follows the above power derating curve.						
Rated Voltage	$\sqrt{\text{Rated power(w)} \times \text{Normal resistance value (W)}}$						
Working Voltage (Max)	50V	50V	50V	150V	200V	200V	200V
Overload Voltage (Max)	100V	100V	100V	300V	400V	400V	400V
Resistance Range	(UNIT: Ω)						
D(±0.5%)	-	10~1M	10~1M	10~1M	10~1M	-	-
F(±1%), G(±2%)	10~1M	10~1M	10~1M	10~1M	10~1M	10~1M	10~1M
J(±5%)	10~1M	1~10M	1~10M	1~10M	1~10M	1~10M	1~10M
K(±10%)	10~1M	1~10M	1~10M	1~10M	1~10M	1~10M	1~10M
Jumper Chip	50 mΩ max						
Operating Temperature Range	-55℃ ~ 125℃ -55℃ ~ 155℃ (For 1608, 2012, 3216)						
Rated Temperature Range	70℃						
Temperature Coefficient	Resistance Tolerance	Resistance Range		Temperature Coefficient			
	J (±5%) K (±10%)	1 Ω ≤ R ≤ 10 MΩ		±(300/200) PPM/℃			
		10 Ω ≤ R < 1 MΩ		±100 PPM/℃			
		1 MΩ ≤ R < 10 MΩ		±3 00 PPM/℃			
	G (±2%) F (±1%) D (±0.5%)	10 Ω ≤ R < 1 MΩ		±100 PPM/℃			

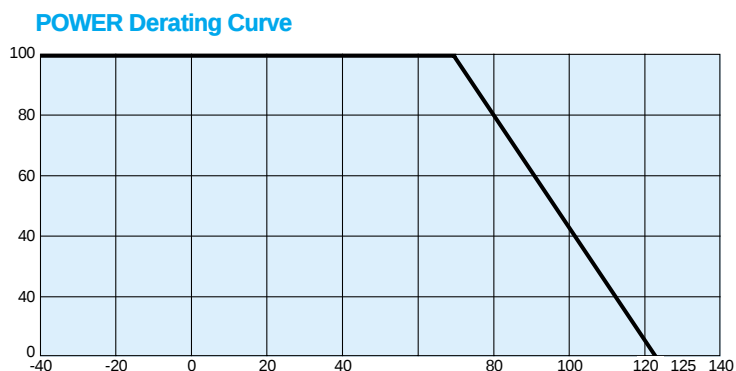
* Please specify wattage when power rathing at the mark(*) is required at the time of ordering.

THICK FILM CHIP RESISTORS

SPECIFICATION IN THE LOW RESISTANCE RANGE

Description	RC2012	RC3216	RC3225	RC5025	RC6432
Power Rating (W) at 70℃	0.10W	0.125W *0.25W	0.25W	0.5W	1W

Power Derating Curve



The rated power is the maximum continuous loading power at 70℃ ambient temperature.
For ambient temperature's above 70℃ the loading power follows the above power derating curve.

Rated Voltage

$$\sqrt{\text{Rated power (W)} \times \text{Normal resistance value (}\Omega\text{)}}$$

Working Voltage (Max)	50V	100V	200V	200V	200V
Overload Voltage (Max)	100V	200V	400V	400V	400V

Resistance range

(UNIT : Ω)

F(±1%)	0.2 Ω ~ 0.91 Ω (E24 Series)
G(±2%)	
J(±5%)	
K(±10%)	

Operating temperature range

-55℃ ~ 125℃

Rated Ambient Temperature

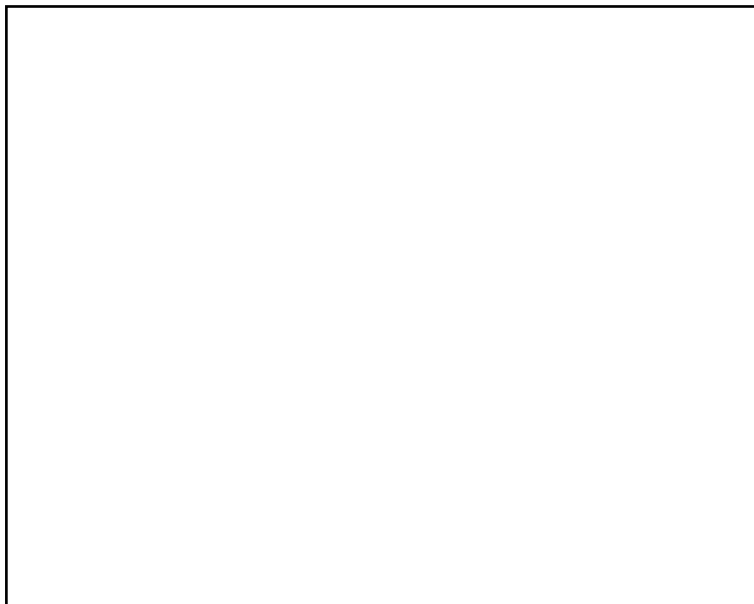
70℃

Temperature Coefficient

Resistance Tolerance	Resistance Range	Temperature Coefficient
F(±1%)	0.2 Ω ≤ R ≤ 1 Ω	±200 PPM/℃
G(±2%)	0.2 Ω ≤ R ≤ 1 Ω	±200PPM/℃
J(±5%)	0.2 Ω ≤ R ≤ 1 Ω	±(600/300)PPM/℃
K(±10%)	0.2 Ω ≤ R ≤ 1 Ω	±(600/300)PPM/℃

* Please specify wattage when power rathing at the mark(*) is required at the time of ordering.

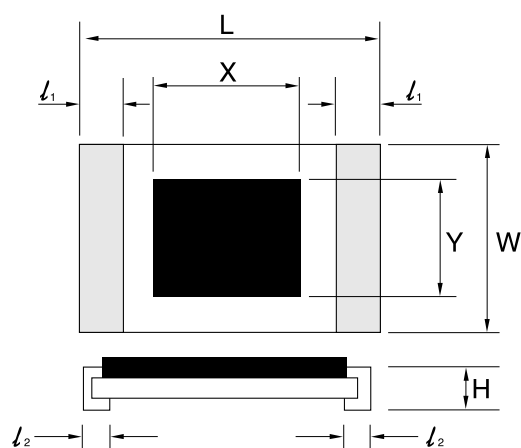
TRIMMABLE CHIP RESISTOR



FEATURES

- Available in use of function trimming.
- Compatible with both wave and reflow soldering.
- Highly stable in auto-placement surface mounting application.
- Excellent electrical characteristic.

DIMENSIONS



X, Y : Trimming area

(Unit : mm)

TYPE	L	W	H	l ₁	l ₂	X	Y
RT1608	1.60±0.10	0.80±0.15	0.45±0.10	0.30±0.20	0.35±0.10	0.50±0.10	0.40±0.10
RT2012	2.00±0.20	1.25±0.15	0.50±0.10	0.40±0.20	0.35±0.20	0.70±0.10	0.60±0.10
RT3216	3.20±0.20	1.60±0.15	0.55±0.10	0.45±0.20	0.40±0.20	1.30±0.10	1.00±0.10

THICK FILM CHIP RESISTORS

GENERAL SPECIFICATION

RT	2012	M	100	CS
Code Designation	Dimension (mm)	Resistance Tolerance	Resistance Value	Packaging Code
Trimmable Chip Resistor	1608:1.6×0.8 2012:2.0×1.25 3216:3.2×1.6	$K = \pm 10\%$	E12 Series E6 Series (IEC Coding system)	CS : Tape Packaging GS : Bulk Packaging

* RT:DIP Type(Major)

RATING

Type	Power Rating	Working Voltage (MAX)	Over load Voltage (MAX)	Resistance Range	Operating Temperature Range	Rating Ambient Temperature	Temperature Coefficient
RT1608	1/16 W	50 V	100 V	1~10 M Ω	-55 °C ~ +125 °C	+70 °C	$\pm 200\text{ppm}/^{\circ}\text{C}$ $\pm 300\text{ppm}/^{\circ}\text{C}$
RT2012	1/10W	100 V	200 V	1~10 M Ω			
RT3216	1/8W	200 V	400 V	1~10 M Ω			
	1/4W	200 V	400 V	1~10 M Ω			

www.DataSheet4U.com

PACKAGING

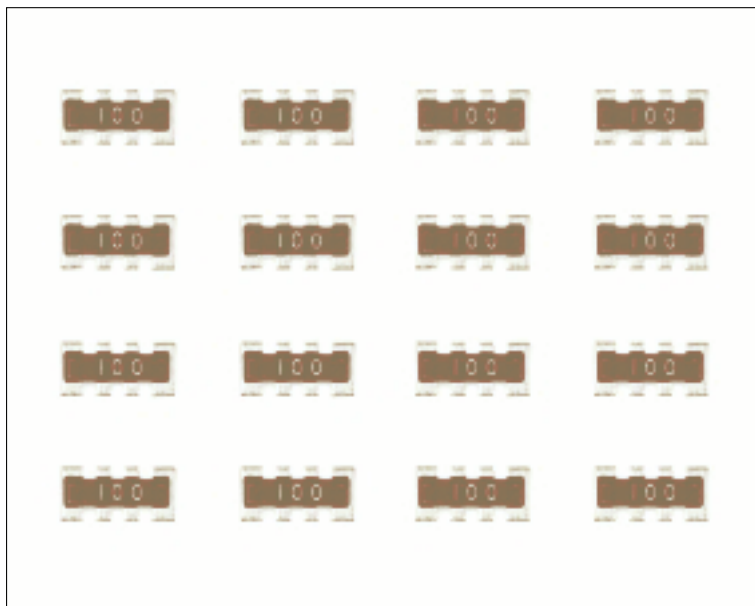
- The Chip Network Resistors can be supplied with packaged carrier tape for effective use in SMD machine.
- All Reel taping specifications are in accordance with EIAJ RC-1009.
- Standard Quantity :

7 inch reel	5,000/1 reel
13 inch reel	20,000/1 reel

- Chip Resistor for Bulk shall be in the polyethylene bag and Quantity of the Chip Resistors in bag is determined by customer orders.(Standard Quantity : 5,000EA)

THICK FILM CHIP RESISTORS

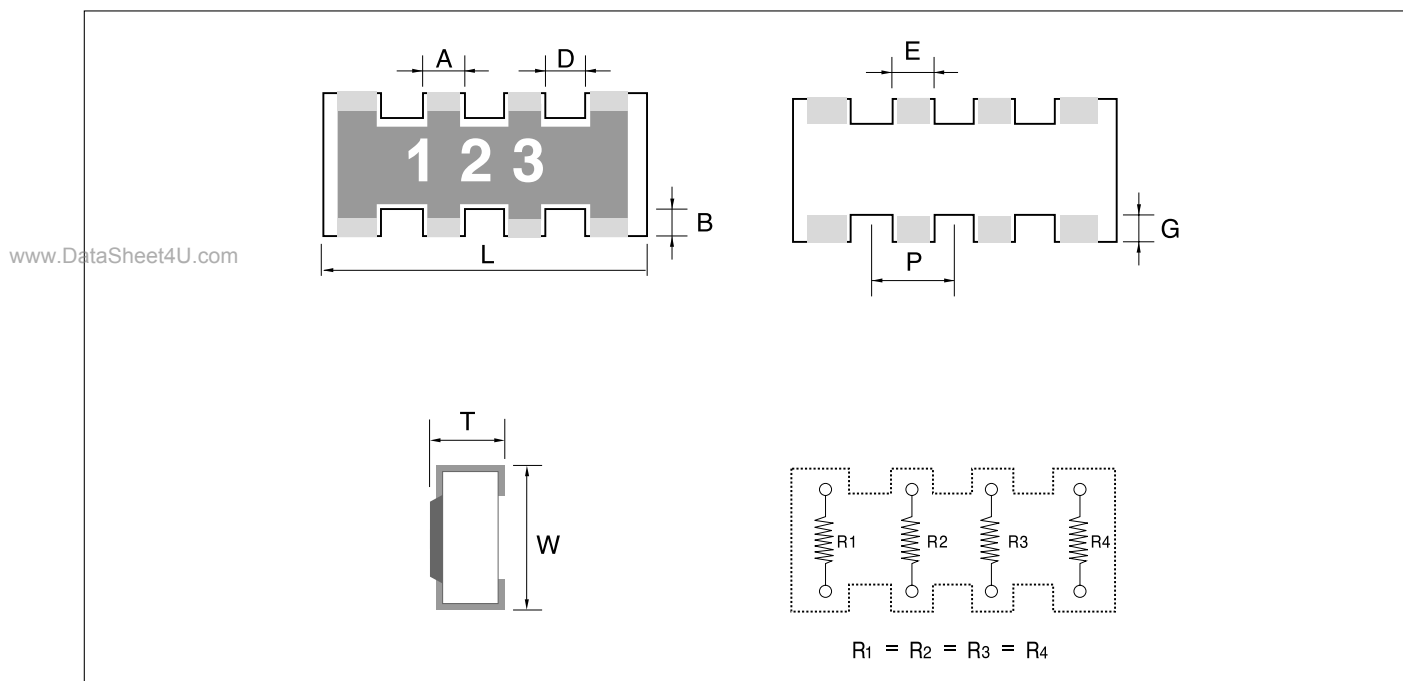
R/R TYPE CHIP NET WORK RESISTOR



FEATURES

- High density mouting
- Improvement of placement efficiency.
- Automatic placement.

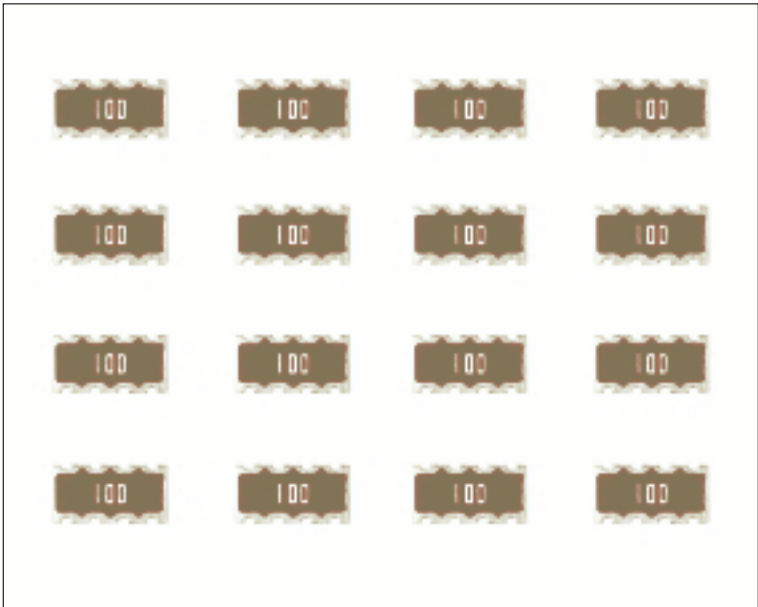
DIMENSIONS



UNIT [mm]

TYPE	L	W	T	A	D	B	P	E	G
RR164P	3.2 ± 0.2	1.5 ± 0.2	0.5 ± 0.2	0.5 ± 0.2	Max 0.16	0.25 ± 0.2	0.8 ± 0.15	0.5 ± 0.2	0.25 ± 0.2

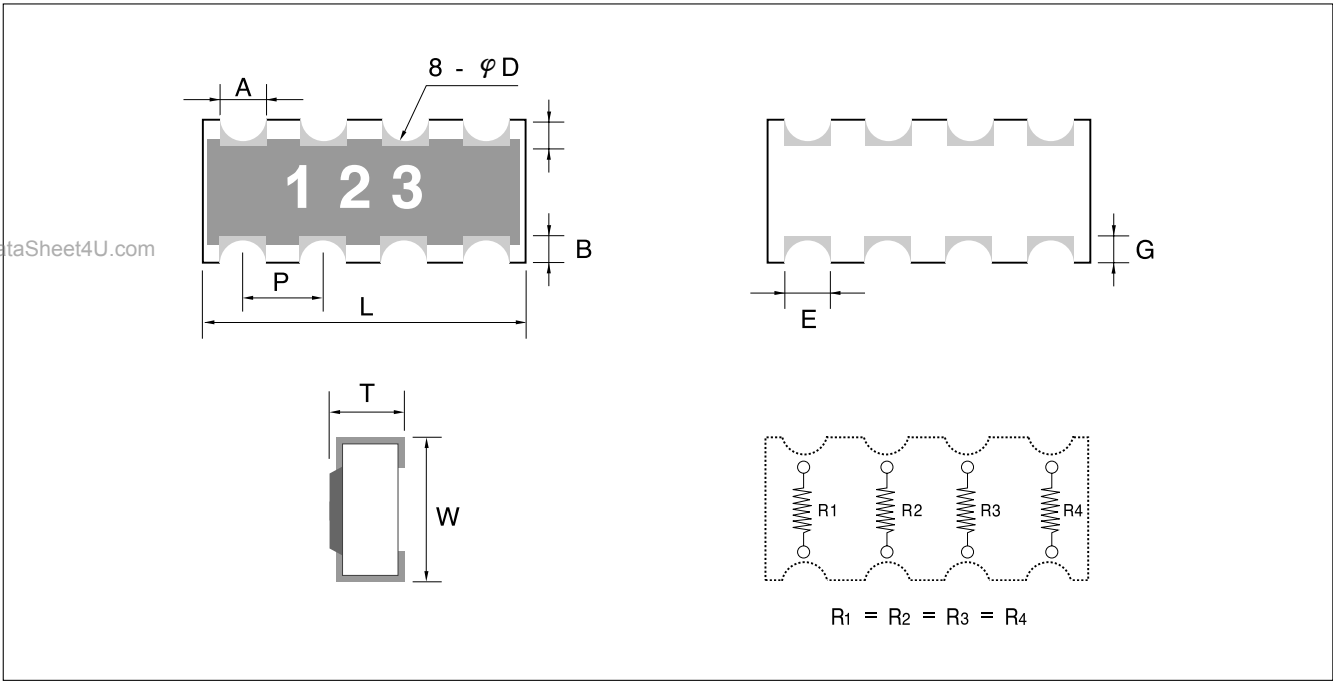
R/R TYPE CHIP NET WORK RESISTOR



FEATURES

- High density mouting
- Improvement of placement efficiency.
- Automatic placement.

DIMENSIONS



UNIT [mm]									
TYPE	L	W	T	A	D	B	P	E	G
RN164P	3.2±0.2	1.6±0.2	0.6±0.1	0.45±0.1	0.3±0.1	0.3±0.2	0.8±0.1	0.45±0.1	0.40±0.15

THICK FILM CHIP RESISTORS

PARTS NUMBERING SYSTEM

RP/RN	16/10	4P	J	103	CS
Code Designation	Dimension (mm)	Number of Resistors	Resistance Tolerance	Resistance Value	Packaging Code
Chip Network Resistor	16:1608 Type 10:1005 Type	4p : 4 Resistors	G : $\pm 2\%$ J : $\pm 5\%$ K : $\pm 10\%$	E24 Series (IEC Coding system)	CS/AS/ES : Tape Packaging GS : Bulk Packaging

* RP, RR : Dip Type(Convex Type)

* RN : Through Hole Type(Concave Type)

RATING

Type	Power Rating	Working Voltage (MAX)	Overload Voltage (MAX)	Resistance Range	Operating Temperature Range	Rating Ambient Temperature	Temperature Coefficient
RP104P	1/16W	50V	100V	10~1M	-55 ~ 125°C	+70°C	± 250 PPM/°C
RP164P	1/16W	50V	100V	10~1M	-55 ~ 125°C	+70°C	± 250 PPM/°C
RN164P	1/16W	50V	100V	10~1M	-55 ~ 125°C	+70°C	± 250 PPM/°C

www.DataSheet4U.com

PACKAGING

- The Chip Network Resistors can be supplied packaged carrier tape for effective use SMD machine.
- All Reel taping specifications are in accordance with EIAJ RC-1009.
- Standard Quantity :

7 inch reel	5,000EA/1 reel
10 inch reel	10,000EA/1 reel
13 inch reel	20,000EA/1 reel(15,000EA/1reel)

- Chip Network Resistor for Bulk shall be in the plastic case and Quantity of the Chip Resistors in bag is determined by customer orders.(Standard Quantity : 5,000EA)

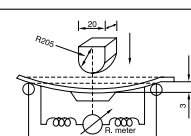
THICK FILM CHIP RESISTORS

CHARACTERISTICS PERFORMANCE

ELECTRICAL CHARACTERISTICS

Item	Specification	Test Method														
Direct Current Resistance	Within the regulated resistance tolerance. Jumper chip $\leq 50 \text{ M}\Omega$	Applying time:within 5 sec <table><tr><th>Resistance range(Ω)</th><th>Max test voltage(V)</th></tr><tr><td>$R < 100$</td><td>0.3</td></tr><tr><td>$100 \leq R < 1\text{K}$</td><td>1.0</td></tr><tr><td>$1\text{K} \leq R < 10\text{K}$</td><td>3</td></tr><tr><td>$10\text{K} \leq R < 100\text{K}$</td><td>10</td></tr><tr><td>$100\text{K} \leq R < 1\text{M}$</td><td>25</td></tr><tr><td>$1\text{M} \leq R$</td><td>50</td></tr></table>	Resistance range(Ω)	Max test voltage(V)	$R < 100$	0.3	$100 \leq R < 1\text{K}$	1.0	$1\text{K} \leq R < 10\text{K}$	3	$10\text{K} \leq R < 100\text{K}$	10	$100\text{K} \leq R < 1\text{M}$	25	$1\text{M} \leq R$	50
Resistance range(Ω)	Max test voltage(V)															
$R < 100$	0.3															
$100 \leq R < 1\text{K}$	1.0															
$1\text{K} \leq R < 10\text{K}$	3															
$10\text{K} \leq R < 100\text{K}$	10															
$100\text{K} \leq R < 1\text{M}$	25															
$1\text{M} \leq R$	50															
T.C.R(Resistance Temperature Characteristic)	$1 \leq R < 10$: $+300\text{ppm}/^{\circ}\text{C}$ $-200\text{ppm}/^{\circ}\text{C}$ $10 \leq R < 1\text{M}$: $\pm 100\text{ppm}/^{\circ}\text{C}$ $1\text{M} \leq R \leq 10\text{M}$: $\pm 300\text{ppm}/^{\circ}\text{C}$	Test temperature($^{\circ}\text{C}$) (20) $\rightarrow$ (-55) $\rightarrow$ (20) $\rightarrow$ (125) $\rightarrow$ (20) $\text{T.C.R}(\text{ppm}/^{\circ}\text{C}) = (\text{R}-\text{Ro})/\text{Ro} \times 1/(\text{T}-\text{To}) \times 10^6$ $\text{T} = 20(^{\circ}\text{C})$ T = Test temperature($^{\circ}\text{C}$) Ro = Resistance at room temperature(Ω) R = Resistance at T (Ω)														
Short-time Overload	$\Delta \text{R} : \leq \pm (1\% + 0.1 \Omega)$ of the initial value Visual : No evidence of mechanical damage Jumper chip : $\leq 50 \text{ M}\Omega$	Apply 2.5 times rated voltage for 5sec. Wait 30 minutes at room temperature and measure the resistance value.														
Intermittent Overload	$\Delta \text{R} : \leq \pm (3\% + 0.1 \Omega)$ of the initial value Visual : No evidence of mechanical damage Jumper chip : $\leq 50 \text{ M}\Omega$	Perform 10,000 cycles at 2.5 times RCW or the Max. over load voltage ON(2.5 times rated volage) : 1 sec OFF : 25 sec Have stabilization time of 30 minutes without loading and measure resistance.														
Dielectric withstanding Voltage	No evidence of mechanical damage.	Apply AC 500V for 1 minute. 1005(1/16W), 1608(1/16W):Apply AC 100V for 1 minute														
Insulation Resistance	Over the 1000 $\text{M}\Omega$	Apply DC 500V for 1 minute. 1005(1/16W), 1608(1/16W):Apply DC 100V for 1 minute														

MECHANICAL CHARACTERISTICS

Item	Specification	Test Method												
Solderability	Coverage : $\geq 95\%$ each termination. Visual : No crack of termination parts and ceramic exposure of surface by melting	After immersing in flux, dip into the $235 \pm 5^{\circ}\text{C}$ molten solder for 2 ± 0.5 sec Solder : S63A(KSD 6704) Flux : ROSIN(KSM 2951) Flux is the composition of ROSIN and the methanol Weight rate of ROSIN is about 25%												
Bending Test	$\Delta R : \leq \pm(0.5\%+0.05 \Omega)$ of the initial value Visual : No evidence of mechanical damage.	After soldering resistor on the PCB, 3mm of bending shall be applied for 10 sec. Material of PCB : Glass Epoxy Thickness : 1.6mm Measure resistance during load application 												
Terminal Strenght	Load pull : $\geq 0.5\text{kg}$ 1005(1/16W), 1608(1/16W) $\geq 0.3\text{kg}$	pull Direction fixed 0.4 lead 												
Terminal Strenght	$\Delta R : \leq \pm(1\%+0.05 \Omega)$ of the initial value Visual : No evidence of mechanical damage.	Immerse in molten solder at $260 \pm 5^{\circ}\text{C}$ for 10 ± 1 sec. Preheat and soldering Procedure <table><tr><th>Temperature($^{\circ}\text{C}$)</th><th>Time(sec)</th></tr><tr><td>80 - 100</td><td>120</td></tr><tr><td>150 - 180</td><td>120</td></tr><tr><td>260 + 5</td><td>10</td></tr><tr><td>150 - 180</td><td>60</td></tr><tr><td>80 - 100</td><td>60</td></tr></table> Solder : S63A(SSD 6704) Flux : The composition of ROSIN (KSM295)25% and methanol (KSM 1658)75%	Temperature($^{\circ}\text{C}$)	Time(sec)	80 - 100	120	150 - 180	120	260 + 5	10	150 - 180	60	80 - 100	60
Temperature($^{\circ}\text{C}$)	Time(sec)													
80 - 100	120													
150 - 180	120													
260 + 5	10													
150 - 180	60													
80 - 100	60													
Anti-Vibration Test	$\Delta R : \leq \pm(1\%+0.05 \Omega)$ of the initial value Visual : No evidence of mechanical damage.	2 hours each in X, Y, and Z axis(toyal 6 hours) 10 to 55 Hz sweep in 1 minute amplitude.												

THICK FILM CHIP RESISTORS

ELECTRICAL CHARACTERISTICS

Item	Specification	Test Method															
Low Temperature exposure	$\Delta R : \leq \pm (3\% + 0.1 \Omega)$ of the initial value. Visual : No evidence of mechanical damage.	Dwell in $-55 \pm 3^\circ\text{C}$ chamber without loading for 1000 ± 12 hours Dwell for 60 minutes at Room temperature and Measure resistance value.															
Temperature Cycle	$\Delta R : \leq \pm (1\% + 0.1 \Omega)$ of the initial value. Visual : No evidence of mechanical damage.	Perform 100Cycles as follows. <table> <tr> <th>No.</th><th>Temperature($^\circ\text{C}$)</th><th>Time(min)</th></tr> <tr> <td>1</td><td>-55 ± 3</td><td>30</td></tr> <tr> <td>2</td><td>20 ± 3</td><td>15</td></tr> <tr> <td>3</td><td>125 ± 3</td><td>30</td></tr> <tr> <td>4</td><td>20 ± 3</td><td>15</td></tr> </table>	No.	Temperature($^\circ\text{C}$)	Time(min)	1	-55 ± 3	30	2	20 ± 3	15	3	125 ± 3	30	4	20 ± 3	15
No.	Temperature($^\circ\text{C}$)	Time(min)															
1	-55 ± 3	30															
2	20 ± 3	15															
3	125 ± 3	30															
4	20 ± 3	15															
Load Life in Moisture	At $R < 10 \Omega$ $\Delta R : \leq \pm 5\%$ At $R < 1 \text{ M}\Omega$ $\Delta R : \leq \pm (3\% + 0.1 \Omega)$ At $R \geq 1 \text{ M}\Omega$ $\Delta R : \leq \pm 5\%$ Visual : No evidence of mechanical damage.	Temperature : $40 \pm 2^\circ\text{C}$ RH : 90~95% Applying rated voltage for 90 minutes "ON" and 30minutes"OFF" Duration : 1000 hours Dwell in Room temperature for 1 hour and measure resistance value.															
Load Life in high Temperature	At $R < 10 \Omega$ $\Delta R : \leq \pm 5\%$ At $R < 1 \text{ M}\Omega$ $\Delta R : \leq \pm (3\% + 0.1 \Omega)$ At $R > 1 \text{ M}\Omega$ $\Delta R : \leq \pm 5\%$	Temperature : $70 \pm 3^\circ\text{C}$ at rated voltage. Applying rated voltage for 90 minutes "ON" and 30minutes"OFF" Duration : 1000 hours Dwell in Room temperature for 1 hour and measure resistance value.															
Heat Resistance (High Temperature Exposure)	$\Delta R : \leq \pm (3\% + 0.1 \Omega)$ of the initial value. Visual : No evidence of mechanical damage.	Dwell in $125 \pm 3^\circ\text{C}$ chamber without loading for 1000 ± 12 hours Dwell in Room temperature for 1 hour and measure resistance value.															

THICK FILM CHIP RESISTORS

PACKAGING

- The Chip Resistor can be supplied with packaged carrier tape for effective use in SMD machine.
- All Reel taping specifications are in accordance with EIAJ RC-1009.
- Standard Quantity :

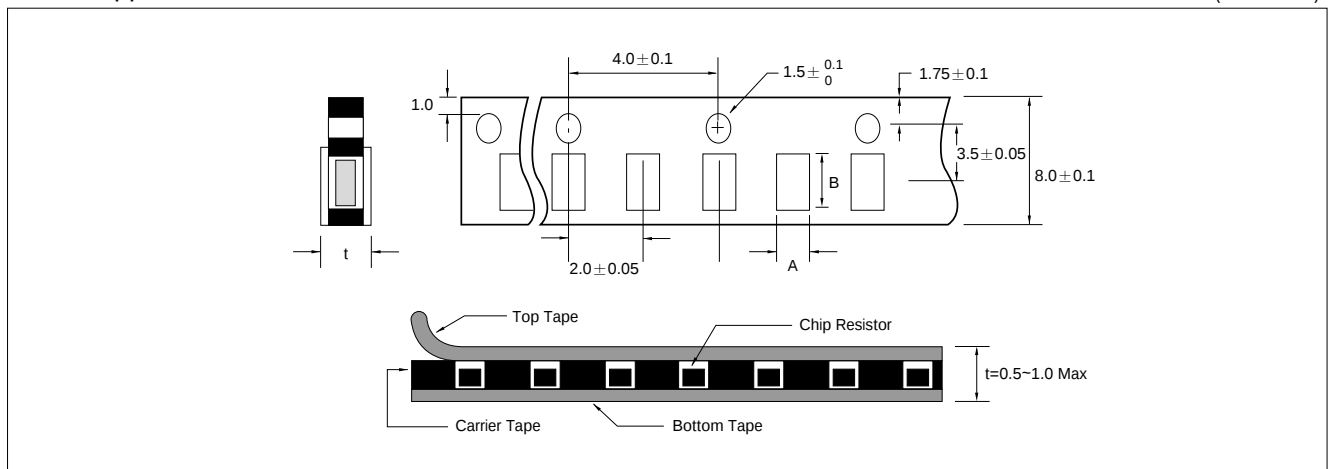
REEL SIZE	1005	1608, 2012, 3216	5025, 6432
7 inch reel	10,000EA/1 reel	5,000EA/1 reel	4,000EA/1 reel
10 inch reel	-	10,000EA/1 reel	-
13 inch reel	40,000EA/1 reel	20,000EA/1 reel	15,000EA/1 reel

- Chip Resistor for Bulk shall be in the plastic Quantity of the
Chip Resistors in bag is determined by custom orders.(Standard Quantity : 5,000EA)

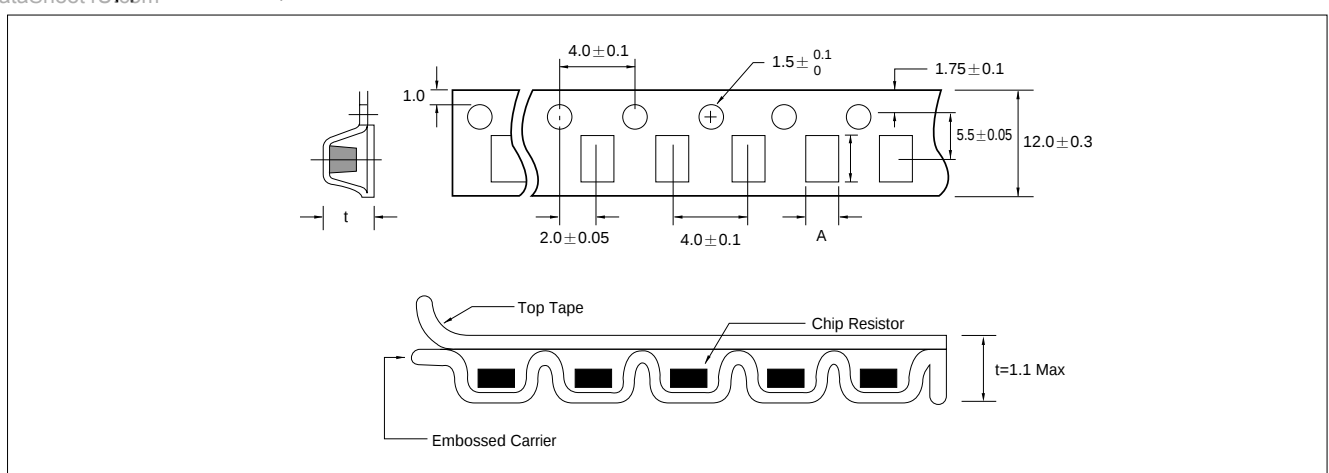
CARRIER TAPE DIMENSIONS

- This is applied to 1005 series.

(Unit: mm)



- This is applied to 5025, 6432 series.



• WINDOW DIMENSIONS

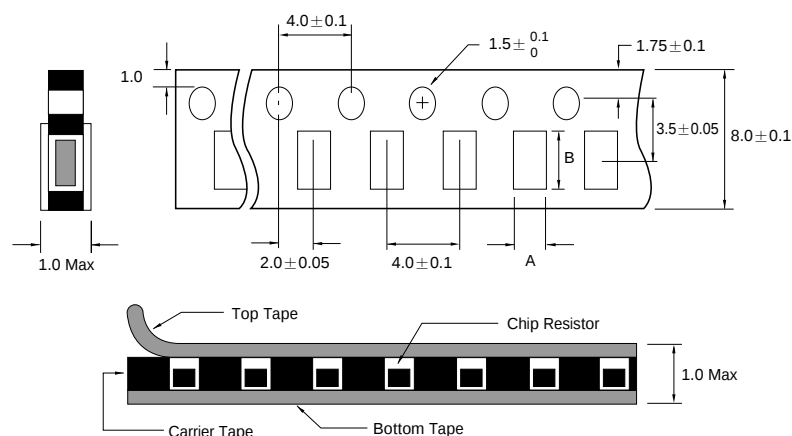
(mm)

SIGN.	ITEM	RC 1005 (1/16W)	RC 5025 (1/2W)	RC 6432 (1W)
A		0.7 ± 0.10	2.80	3.50 ± 0.10
B		1.20 ± 0.10	5.32 ± 0.20	6.75 ± 0.10
t		0.5(MAX)	1.10(MAX)	1.10(MAX)

THICK FILM CHIP RESISTORS

► This is applied to 1608, 2012, 3216, 3225 series

(Unit: mm)

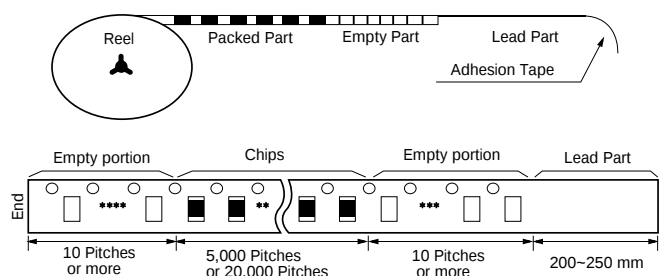


• WINDOW DIMENSIONS

(mm)

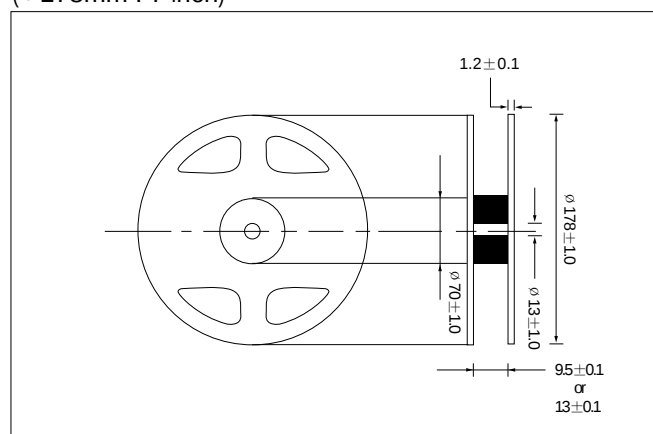
SIGN.	ITEM	RC 1608 (1/16W)	RC 2012 (1/10W)	RC 3216 (1/8, 1/4W)	RC 3225 (1/4W)
A		1.10 ± 0.20	1.65 ± 0.20	2.00 ± 0.20	2.90 ± 0.20
B		1.90 ± 0.20	2.40 ± 0.20	3.60 ± 0.20	3.60 ± 0.20
t		0.90(MAX)	1(MAX)	1(MAX)	1(MAX)

TAPING METHOD



REEL DIMENSIONS

($\phi 178$ mm : 7 inch)



($\phi 330$ mm : 13 inch)

